

Subject: Product Specification change regarding corporate logo & factory location,
Of the 2.4GHz band LR-WPAN module (PAN802154HAR00)

Bulletin#: TBD

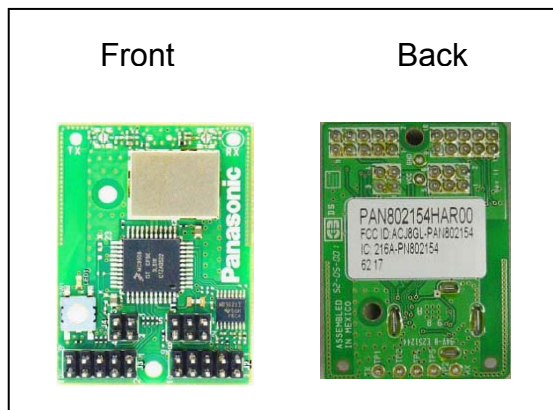
Date: 06/14/06

Effective date: June-13, 2006

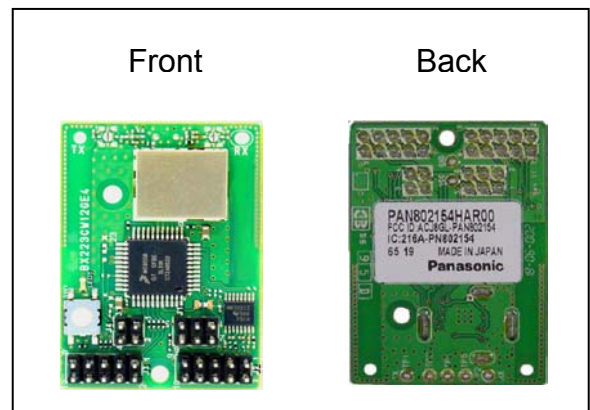
Engineering change details:

- 1) Panasonic Logo positioning from front side PCB to back side Label.
- 2) From “Assembled in Mexico” on the back side of PCB, to “Made in Japan” described on back side Label.

From



To



Reason for change: Production location change from Mexico to Japan.